

30V Half Bridge Dual N-Channel Enhancement Mode Power MOSFET

Description

The NCEB301Q is designed to provide a high efficiency synchronous buck power stage with optimal layout and board space utilization. It includes two specialized MOSFETs in a dual Power DFN3X3 package. The Q1 "High Side" MOSFET is desgined to minimze switching losses. The Q2"Low Side" MOSFET uses advanced trench technology and design to provide excellent $R_{\text{DS(ON)}}$ with low gate charge.

General Features

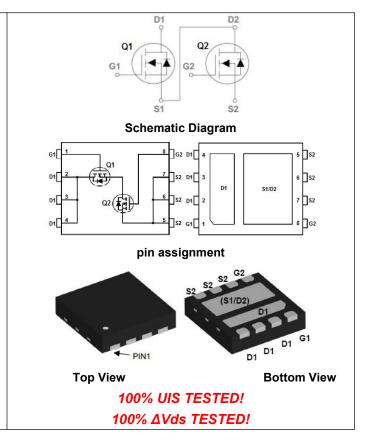
Q1 "High Side" MOSFET Q2 "Low Side" MOSFET

$$\begin{split} \bullet \ V_{DS} = & 30 V, I_D = 15 A & V_{DS} = & 30 V, I_D = 20 A \\ R_{DS(ON)} < & 11.5 m\Omega \ @ \ V_{GS} = & 10 V & R_{DS(ON)} < 9.6 m\Omega \ @ \ V_{GS} = & 10 V \\ R_{DS(ON)} < & 19 m\Omega \ @ \ V_{GS} = & 4.5 V & R_{DS(ON)} < 16 m\Omega \ @ \ V_{GS} = & 4.5 V \end{split}$$

- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

• Compact DC/DC converter applications



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEB301Q	NCEB301Q	DFN3X3-8L	-	-	-

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Paramet	Symbol	Q1	Q2	Unit		
Drain-Source Voltage	V_{DS}	30	30	V		
Gate-Source Voltage	V _{GS}	±20	±20	V		
Drain Current Continuous (Note 2)	T _C =25°C		15	20	А	
Drain Current-Continuous (Note 2)	T _C =100°C	- I _D	10.6	14.1	Δ.	
Drain Current -Pulsed (Note 1)		I _{DM}	60	80	A	
Power Dissipation	T _C =25°C	P _D	18	20	W	
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55 To 150	-55 To 150	$^{\circ}$	

Thermal Characteristic

Parameter	Symbol	Тур	Max	Unit
Thermal Resistance, Junction-to-Case (Note 2) (Q1)	Rejc	6.5	7	°C/W
Thermal Resistance, Junction-to-Case (Note 2) (Q2)	R _{θJC}	6	6.3	°C/W

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Q1 Electrical Characteristics (T_C=25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics				•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	30	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	,		•	•		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250μA	1.0	1.5	2.2	V
Dunin Course On State Begintered	Б	V _{GS} =10V, I _D =10A	-	9.8	11.5	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =10A	-	15.3	19	mΩ
Gate resistance	Rg	V _{DS} =0V,V _{GS} =0V,F=1.0MHz	1.0	2.8	4.3	Ω
Forward Transconductance	g FS	V _{DS} =5V,I _D =10A	-	12	-	S
Dynamic Characteristics (Note4)			•	•		
Input Capacitance	Clss	\/ 45\/\\ 0\/	-	690	-	PF
Output Capacitance	Coss	V _{DS} =15V,V _{GS} =0V,	-	105	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	80	-	PF
Switching Characteristics (Note 4)	·					
Turn-on Delay Time	t _{d(on)}		-	5	-	nS
Turn-on Rise Time	t _r	V_{DD} =15V, R_L =0.75 Ω	-	3.5	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =3 Ω	-	19	-	nS
Turn-Off Fall Time	t _f		-	3.5	-	nS
Total Gate Charge	Qg	\/ 45\/ L 40A	-	15		nC
Gate-Source Charge	Q _{gs}	V _{DS} =15V,I _D =10A,	-	2.5		nC
Gate-Drain Charge	Q_{gd}	- V _{GS} =10V	-	3		nC
Drain-Source Diode Characteristics	·		•	•		
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =10A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	15	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =10A	-	19	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	10	-	nC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,VDD=15V,VG=10V,L=0.5mH,Rg=25 Ω



Q1Typical Electrical and Thermal Characteristics (Curves)

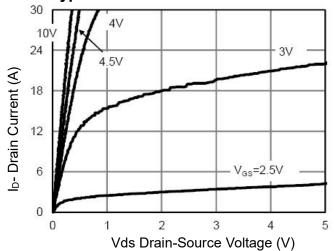


Figure 1 Output Characteristics

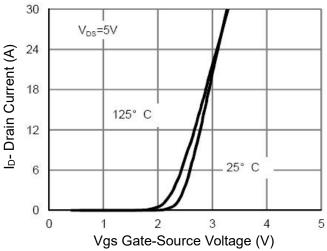
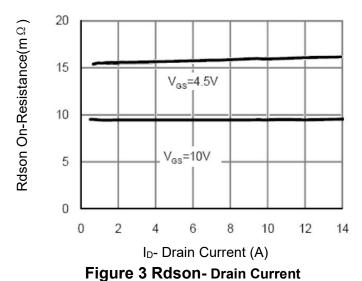


Figure 2 Transfer Characteristics



1.8 Normalized On-Resistance V_{gs}=10V I_D=10A 1.6 1.4 1.2 V_{gs}=4.5V I_D=10A 1 0.8 25 50 75 100 125 150 T_J-Junction Temperature(°C)

Figure 4 Rdson-Junction Temperature

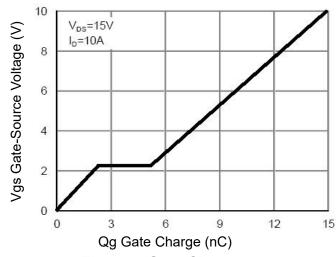


Figure 5 Gate Charge

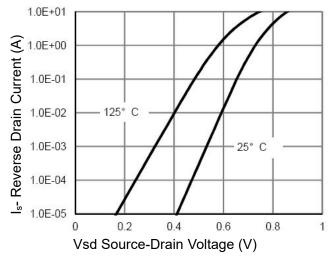
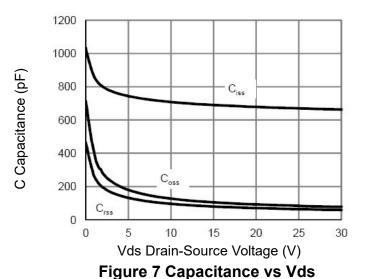


Figure 6 Source- Drain Diode Forward





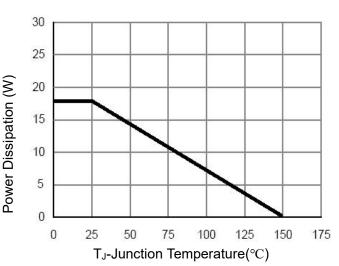


Figure 9 Power De-rating

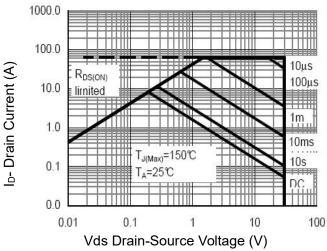


Figure 8 Safe Operation Area

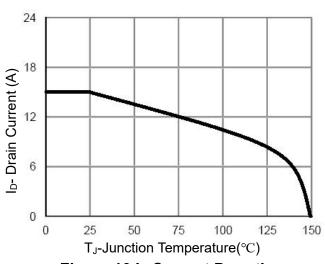
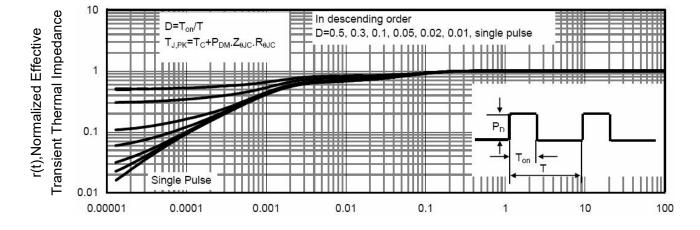


Figure 10 I_D Current De-rating



Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance

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Q2 Electrical Characteristics (TC=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•	•		•
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	30	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250μA	1.0	1.5	2.2	V
Dunin Course On Chata Begintanes	Б	V _{GS} =10V, I _D =10A	-	8.3	9.6	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =10A	-	13	16	mΩ
Gate resistance	Rg	V _{DS} =0V,V _{GS} =0V,F=1.0MHz	0.7	2.1	3.6	Ω
Forward Transconductance	g FS	V _{DS} =5V,I _D =10A	-	15	-	S
Dynamic Characteristics (Note4)	·			•		
Input Capacitance	Clss	\/_45\/_0\/	-	1210	-	PF
Output Capacitance	Coss	V _{DS} =15V,V _{GS} =0V,	-	160	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	105	-	PF
Switching Characteristics (Note 4)	·			•		
Turn-on Delay Time	t _{d(on)}		-	5	-	nS
Turn-on Rise Time	t _r	V_{DD} =15V, R_L =0.75 Ω	-	12	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =3 Ω	-	19	-	nS
Turn-Off Fall Time	t _f		-	6	-	nS
Total Gate Charge	Qg	\/ 45\/ L 40A	-	17.5		nC
Gate-Source Charge	Q _{gs}	V _{DS} =15V,I _D =10A,	-	3		nC
Gate-Drain Charge	Q_{gd}	- V _{GS} =10V	-	4.1		nC
Drain-Source Diode Characteristics	·	•				
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =10A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	20	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =10A	-	19	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	10	-	nC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\mathrm{C}$,V_DD=15V,V_G=10V,L=0.5mH,Rg=25 Ω



Q2Typical Electrical and Thermal Characteristics (Curves)

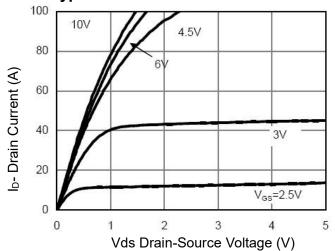


Figure 1 Output Characteristics

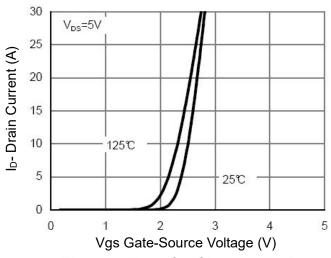
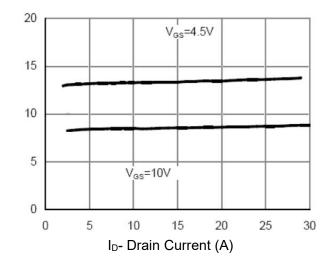


Figure 2 Transfer Characteristics



Rdson On-Resistance(m 🛭)

Figure 3 Rdson- Drain Current

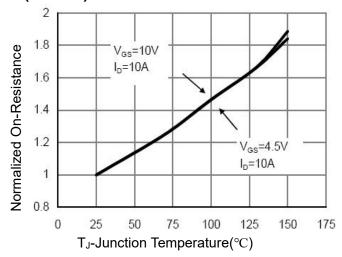


Figure 4 Rdson-Junction Temperature

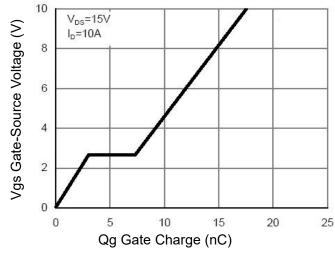


Figure 5 Gate Charge

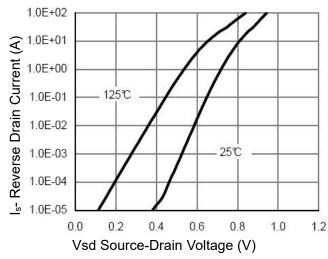
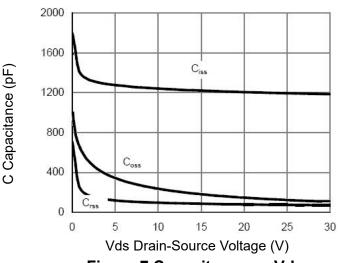


Figure 6 Source- Drain Diode Forward





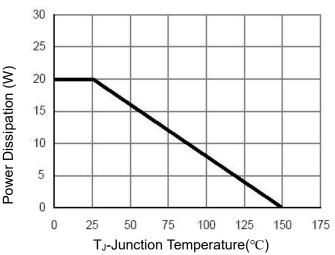
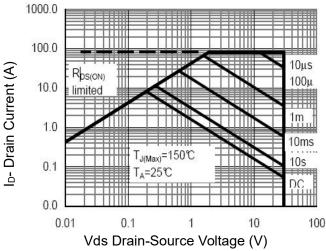


Figure 7 Capacitance vs Vds

Figure 9 Power De-rating



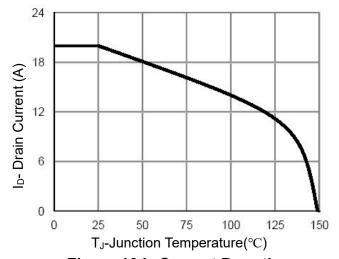
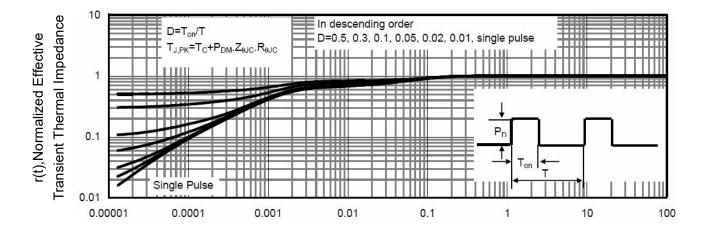


Figure 8 Safe Operation Area

Figure 10 ID Current De-rating

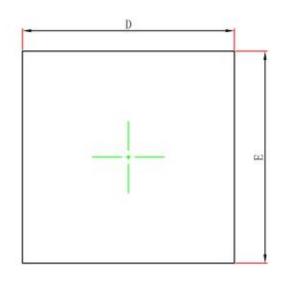


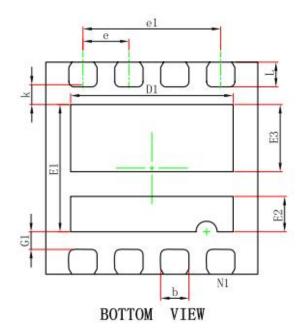
Square Wave Pluse Duration(sec)

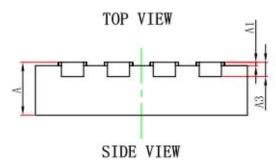
Figure 11 Normalized Maximum Transient Thermal Impedance



DFN3X3-8L Package Information







Symbol	Dimensions II	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A3	0.203	REF.	0.008REF.		
D	2.950	3.050	0.116	0.120	
Е	2.950	3.050	0.116	0.120	
D1	2.250	2.350	0.089	0.093	
E1	1.700	1.900	0.067	0.075	
E2	0.450	0.550	0.018	0.022	
E3	0.900	1.000	0.035	0.039	
k	0.200	0.300	0.008	0.012	
G1	0.200	0.300	0.008	0.012	
b	0.350	0.450	0.014	0.018	
е	0.650BSC		0.026BSC		
e1	1.95BSC		0.077	7BSC	
L	0.300	0.400	0.012	0.016	



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NCEB301Q

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